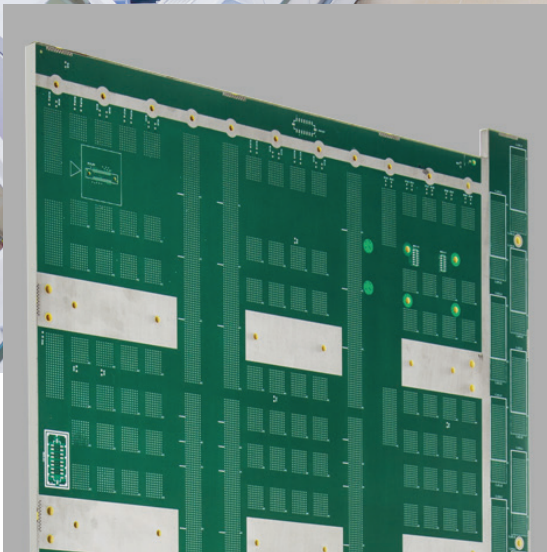




SANMINA

Backplane

One of Most
Experienced
Backplane
Manufacturers
in the World

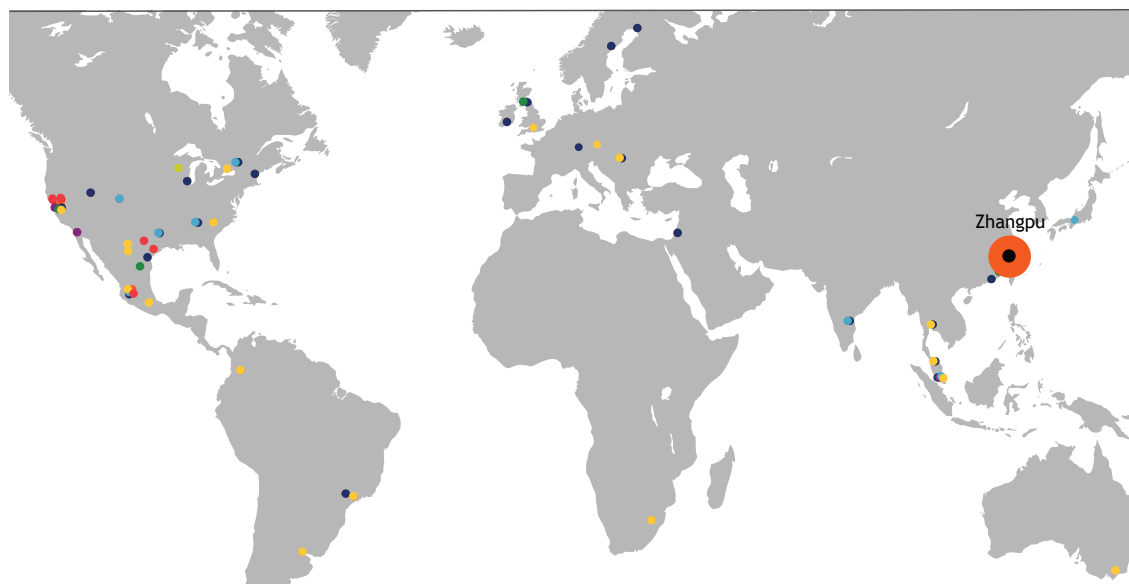


Zhangpu, China



The Sanmina, Kunshan backplane facility specializes in backplane assembly and systems integration, providing customers with a best-cost manufacturing solution for high-technology telecommunications and data-networking backplanes. With on-site engineering support, this facility helps customers with tooling, signal integrity and product verification for efficient manufacturing and new product introduction. Our Kunshan facility is strategically located to provide warehousing and manage imports/exports, offering a competitive advantage for our customers.

Sanmina Worldwide



- CABLES**
 - Zhangpu, CN
 - Monterrey, MX
 - Port Glasgow, UK
 - San Jose, CA

- PLASTICS**
 - Turtle Lake, WI

- GLOBAL SERVICES**
 - Bogota, CO
 - Brno, CZ
 - Buenos Aires, AR
 - El Paso, TX
 - Guadalajara, MX
 - Johannesburg, ZA
 - Penang, MY
 - Tatabánya, HU
 - Thailand, TH
 - Juarez, MX
 - Markham, ON
 - Melbourne, AU
 - Mexico City, MX
 - Sao Paulo, BR
 - Basingstoke, UK
 - Kunshan, CN
 - Singapore, SG
 - San Jose, CA
 - Fort Mill, SC

- PCB**
 - San Jose, CA
 - Costa Mesa, CA
 - Singapore, SG
 - Wuxi, CN

- BACKPLANES**
 - San Jose, CA
 - Guadalajara, MX

- DESIGN CENTERS**
 - Carrollton, TX
 - Chennai, IN
 - Colorado Springs, CO
 - Guadalajara, MX
 - Kanata, ON
 - Singapore, SG
 - Yasu, JP
 - Huntsville, AL

- MECHANICAL SYSTEMS**
 - Austin, TX
 - Fremont, CA
 - Guadalajara, MX
 - Newark, CA
 - Houston, TX
 - Suzhou, CN

- INTEGRATED MANUFACTURING SERVICES**
 - Carrollton, TX
 - Campinas, BR
 - Chennai, IN
 - Fermoy, IR
 - Guadalajara, MX
 - Gunzenhausen, GR
 - Haukipudas, FI
 - Huntsville, AL
 - Kanata, ON
 - Kenosha, WI
 - Kunshan, CN
 - Ma'alot, IL
 - Manchester, NH
 - Örnsköldsvik, SW
 - Pathum Thani, TH
 - Penang, MY
 - Port Glasgow, UK
 - San Jose, CA
 - Shenzhen, CN
 - Singapore, SG
 - Tatabánya, HU
 - Salt Lake City, UT
 - Reynosa, MX

Manufacturing Capabilities

- Backplane Assembly
- Large Backplane Panel Capability
- Chassis-Level System Integration and Test
- Automated Electric Connector Pressing
- Quickturn

Engineering Capabilities

- NPI, DFM and DFT
- Test Engineering and Development
- ECO Management
- Quality Engineering
- Failure Analysis

Testing Capabilities

- ICT, Functional Test and Clamshell Hi-Pot
- EEPROM Programming/Testing
- RoBAT S1 Tester (AOI and Electrical, Dual-Sided)
- Power Up Testing
- Chassis-Level Test and Burn-In

Technologies

- Lead-Free Processes
- Multiple Finished and High-Speed Connector Systems
- Wave and Selective-Wave Soldering
- Dual-Sided Surface Mount
- AOI

Logistics Services

- Direct Fulfillment
- Demand Pull and JIT
- Warehousing and EDI
- RMA, Warranty, Repair and Upgrades
- Regional Test Development

Certifications

- ISO 9001 and ISO 14001
- TL 9000
- IATF 16949
- UL/CSA

ABOUT SANMINA CORPORATION

Sanmina Corporation is a leading integrated manufacturing solutions provider serving the fastest-growing segments of the global Electronics Manufacturing Services (EMS) market. Recognized as a technology leader, Sanmina provides end-to-end manufacturing solutions, delivering superior quality and support to Original Equipment Manufacturers (OEMs) primarily in the medical, communications networks, defense and aerospace, industrial and semiconductor systems, multimedia, computing and storage, automotive and clean technology sectors. Sanmina has facilities strategically located in key regions throughout the world.

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